

IN THE SPECIFICATION

Please replace page 16, paragraph 47 with the following:

B1 [0047] The functional blocks 204 can be coupled to the receptor sites 203 by being flown over the backplane substrate 202 in a slurry solution (not shown). In general, these functional blocks 204 include semiconductors that are manufactured from silicon wafers (or other semiconducting materials). Alternatively, the functional blocks 204 can be a functional microstructure or a micro-scale electronic devices such as integrated circuit (not shown). These functional blocks 204 can also be the micro structure that have been invented and disclosed in a U.S. Patent No. 6,291,896, and which is entitled "Functionally Symmetric Integrated Circuit Die." This patent is hereby incorporated herein by reference.

(Please see Appendix A for the marked up version).